

CXDM6053N

**SURFACE MOUNT
N-CHANNEL
ENHANCEMENT-MODE
SILICON MOSFET**



SOT-89 CASE

APPLICATIONS:

- Load/Power switches
- Power supply converter circuits
- Battery powered portable equipment

MAXIMUM RATINGS: ($T_A=25^\circ\text{C}$)

	SYMBOL		UNITS
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	20	V
Continuous Drain Current (Steady State)	I_D	5.3	A
Maximum Pulsed Drain Current, $t_p=10\mu\text{s}$	I_{DM}	30	A
Power Dissipation	P_D	1.2	W
Operating and Storage Junction Temperature	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$
Thermal Resistance	Θ_{JA}	104	$^\circ\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS: ($T_A=25^\circ\text{C}$ unless otherwise noted)

SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_{GSSF}, I_{GSSR}	$V_{GS}=20\text{V}, V_{DS}=0$			100	nA
I_{DSS}	$V_{DS}=60\text{V}, V_{GS}=0$			1.0	μA
BV_{DSS}	$V_{GS}=0, I_D=250\mu\text{A}$	60			V
$V_{GS(\text{th})}$	$V_{GS}=V_{DS}, I_D=250\mu\text{A}$	1.0	1.3	3.0	V
V_{SD}	$V_{GS}=0, I_S=2.0\text{A}$			1.2	V
$r_{DS(\text{ON})}$	$V_{GS}=10\text{V}, I_D=5.3\text{A}$		30	41	$\text{m}\Omega$
$r_{DS(\text{ON})}$	$V_{GS}=4.5\text{V}, I_D=4.7\text{A}$		33	52	$\text{m}\Omega$
$Q_{g(\text{tot})}$	$V_{DS}=30\text{V}, V_{GS}=5.0\text{V}, I_D=5.3\text{A}$		8.8		nC
Q_{gs}	$V_{DS}=30\text{V}, V_{GS}=5.0\text{V}, I_D=5.3\text{A}$		1.9		nC
Q_{gd}	$V_{DS}=30\text{V}, V_{GS}=5.0\text{V}, I_D=5.3\text{A}$		3.6		nC
C_{rss}	$V_{DS}=30\text{V}, V_{GS}=0, f=1.0\text{MHz}$		53		pF
C_{iss}	$V_{DS}=30\text{V}, V_{GS}=0, f=1.0\text{MHz}$		920		pF
C_{oss}	$V_{DS}=30\text{V}, V_{GS}=0, f=1.0\text{MHz}$		49		pF
t_{on}	$V_{DD}=30\text{V}, V_{GS}=4.5\text{V}, I_D=4.4\text{A}$ $R_G=1.0\Omega, R_L=6.8\Omega$		33		ns
t_{off}	$V_{DD}=30\text{V}, V_{GS}=4.5\text{V}, I_D=4.4\text{A}$ $R_G=1.0\Omega, R_L=6.8\Omega$		42		ns



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CXDM6053N is a high current N-channel enhancement-mode silicon MOSFET, designed for high speed pulsed amplifier and driver applications. This MOSFET offers high current, low $r_{DS(\text{ON})}$, low threshold voltage, and low leakage current.

MARKING: FULL PART NUMBER

FEATURES:

- Low $r_{DS(\text{ON})}$ (52m Ω MAX @ $V_{GS}=4.5\text{V}$)
- High current ($I_D=5.3\text{A}$)
- Logic level compatibility

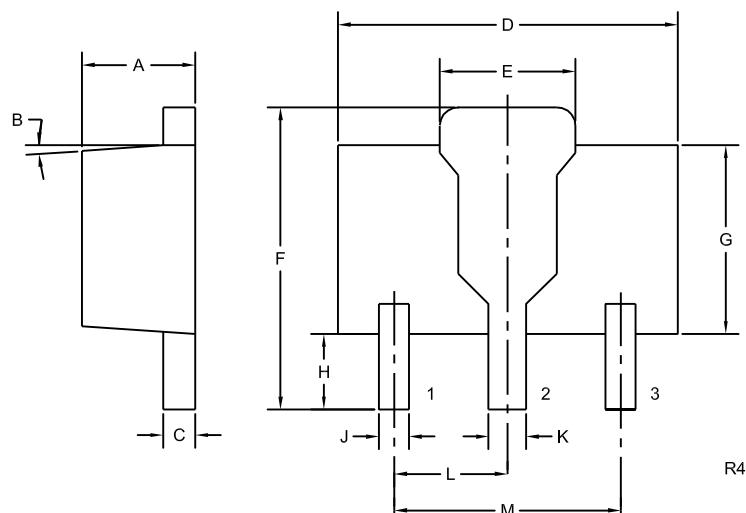
R1 (9-August 2012)

CXDM6053N

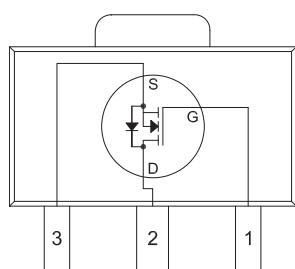
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SOT-89 CASE - MECHANICAL OUTLINE



PIN CONFIGURATION



(Top View)
Tab is common to pin 2

LEAD CODE:

- 1) Gate
- 2) Drain
- 3) Source

MARKING: FULL PART NUMBER

SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.055	0.067	1.40	1.70
B	4°		4°	
C	0.014	0.018	0.35	0.46
D	0.173	0.185	4.40	4.70
E	0.064	0.074	1.62	1.87
F	0.146	0.177	3.70	4.50
G	0.090	0.106	2.29	2.70
H	0.028	0.051	0.70	1.30
J	0.014	0.019	0.36	0.48
K	0.017	0.023	0.44	0.58
L	0.059		1.50	
M	0.118		3.00	

SOT-89 (REV: R4)